

# Schottky Barrier Diodes for Stripline, Microstrip Mixers and Detectors

## Technical Data

5082-2207/09  
5082-2765/85  
5082-2774/94

### Features

- Small Size
- Low Noise Figure  
6 dB Typical at 9 GHz
- Rugged Design
- High Uniformity
- High Burnout Rating  
1 W RF Pulse Power Incident
- Both Medium and Low  
Barrier Available

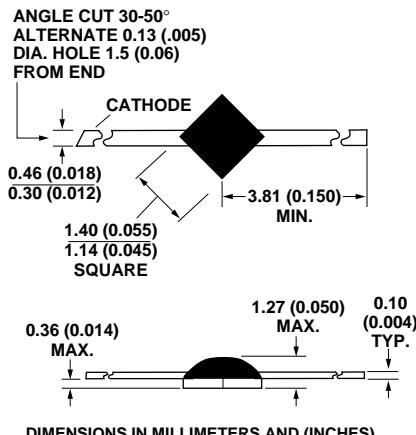
### Description/Applications

This family consists of medium barrier and low barrier beam lead diodes mounted in easily handled carrier packages. Low barrier diodes provide optimum noise figure at low local oscillator drive levels. Medium barrier diodes provide a wider dynamic range for lower distortion mixer designs. Application Note 976 presents design techniques for an X-Band mixer.

**Note:** For new designs, the HSMS-286X and HSMS-820X series of surface mount microwave diodes are recommended.

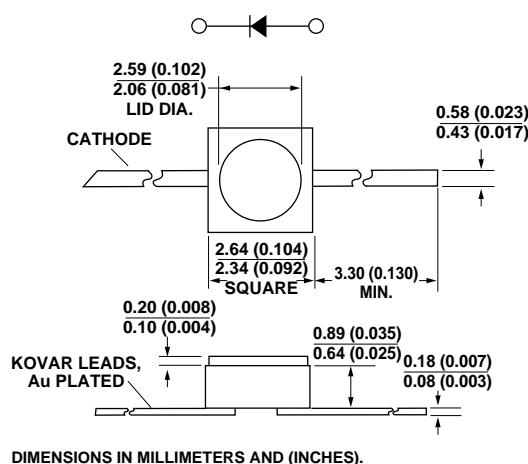
### Outline C2

$$C_P = 0.055 \text{ pF}$$



### Outline H2

$$C_P = 0.175 \text{ pF}$$



### Package Characteristics

These diodes are designed for microstrip and stripline use. The kovar leads provide good continuity of transmission line impedance to the diode. Outline C2 is a plastic on ceramic package. Outline H2 has a metal ceramic hermetic seal. The ceramic is alumina. Metal parts are gold plated kovar.

The hermetic package, outline H2, is capable of passing many of the environmental tests of MIL-STD-750. The applicable solderability test is reference 2031.1: 260°C, 10 seconds.

## Maximum Ratings

Operating and Storage Temperature Range

C2 Packaged Diodes .....	-65°C to +150 °C
H2 Packaged Diodes .....	-65°C to +175 °C
Pulse Power Incident at $T_{CASE} = 25^\circ\text{C}$ .....	1 W (1 $\mu\text{s}$ pulse, $D_u = 0.001$ )
CW Power Dissipation at $T_{CASE} = 25^\circ\text{C}$	125 mW (Measured in an infinite heat sink)
	<i>Derate linearly to zero at maximum operating temperature.</i>
Diode Mounting Temperature in Packages	
C2 .....	235°C for 10 sec max.
H2 .....	260°C for 10 sec max.
Peak Inverse Voltage .....	4 V

These diodes are ESD sensitive. Handle with care to avoid static discharge through the diode.

## RF Electrical Specifications at $T_A = 25^\circ\text{C}$

Part Number 5082-	Test Freq. (GHz)	Barrier	Maximum Noise Figure NF (dB)	IF Impedance $Z_{IF}$ ( $\Omega$ )	Min. Max.	Maximum SWR	Package	Typical Junction Capacitance $C_j$ (pF)
2765	9.375	Low	6.0	150	350	1.5:1	Hermetic H2	0.18
2785		Low	6.5			2.0:1		
2207		Medium	6.0	200	400	1.5:1		
2209		Medium	6.5			2.0:1		
2774		Low	6.0	150	350	1.5:1		
2794		Low	6.5			2.0:1		
Test Conditions			DC Load Resistance = 0 $\Omega$ L.O. Power = 1 mW IF = 30 MHz, 1.5 dB NF					V=0

\*Minimum batch size 20 units.

## Typical Detector Characteristics at $T_A = 25^\circ\text{C}$

### Medium Barrier and Low Barrier (DC Bias)

Parameter	Symbol	Typical Value	Units	Test Conditions
Tangential Sensitivity	$T_{SS}$	-54	dBm	20 $\mu\text{A}$ Bias, $R_L = 100 \text{ K}\Omega$ $P_{in} = -40 \text{ dBm}$ Video Bandwidth = 2 MHz $f = 10 \text{ GHz}$
Voltage Sensitivity	$\gamma$	6.6	mV/ $\mu\text{W}$	
Video Resistance	$R_V$	1400	$\Omega$	

### Low Barrier (Zero Bias)

Parameter	Symbol	Typical Value	Units	Test Conditions
Tangential Sensitivity	$T_{SS}$	-44	dBm	Zero Bias, $R_L = 10 \text{ M}\Omega$ $P_{in} = -30 \text{ dBm}$ Video Bandwidth = 2 MHz $f = 10 \text{ GHz}$
Voltage Sensitivity	$\gamma$	10	mV/ $\mu\text{W}$	
Video Resistance	$R_V$	1.8	$\text{M}\Omega$	

## SPICE Parameters

Parameter	Units	5082-2207	5082-2765
		5082-2209	5082-2774
B <sub>V</sub>	V	5	5
C <sub>J0</sub>	pF	0.20	0.20
E <sub>G</sub>	eV	0.69	0.69
I <sub>BV</sub>	A	10E-5	10E-5
I <sub>S</sub>	A	3x10E-10	4x10E-8
N		1.08	1.08
R <sub>S</sub>	$\Omega$	5	6
P <sub>B</sub>	V	0.65	0.5
P <sub>T</sub>		2	2
M		0.5	0.5

## Typical Parameters

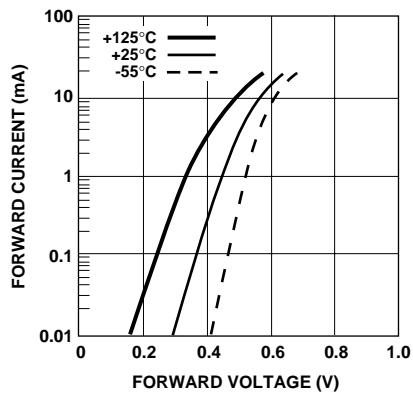


Figure 1. Typical Forward Characteristics for Medium Barrier Diodes.

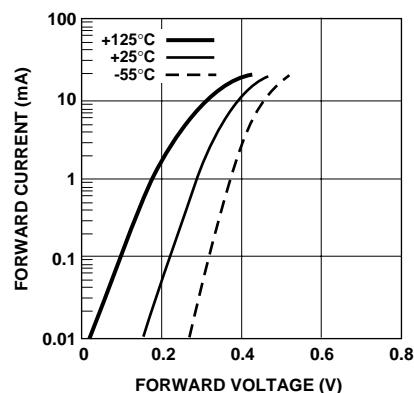


Figure 2. Typical Forward Characteristics for Low Barrier Diodes.

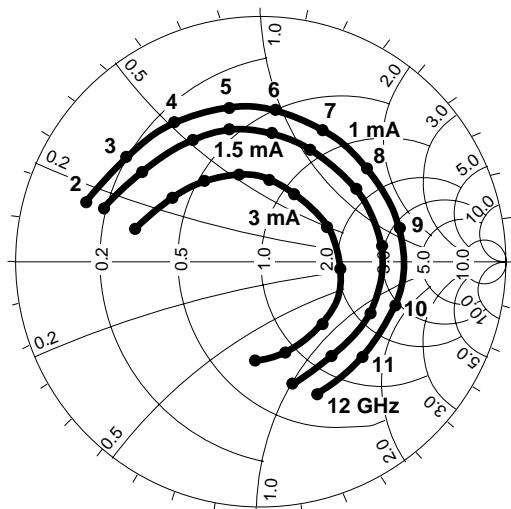


Figure 3. Typical Admittance Characteristics, 5082-2765 with Self Bias.

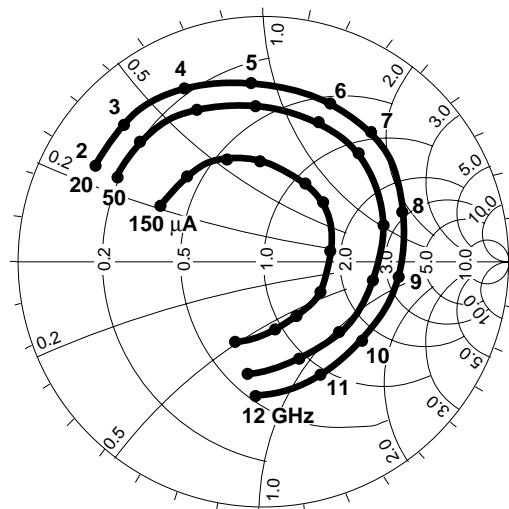


Figure 4. Typical Admittance Characteristics, 5082-2765 with External Bias.

## Typical Parameters, continued

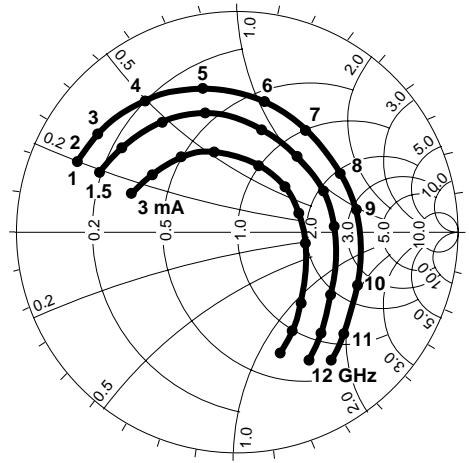


Figure 5. Typical Admittance Characteristics 5082-2785 with Self Bias.

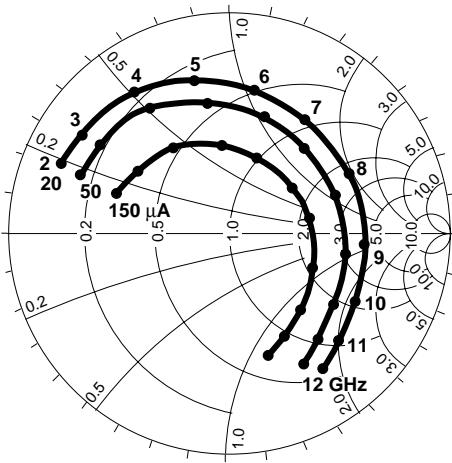


Figure 6. Typical Admittance Characteristics 5082-2785 with External Bias.

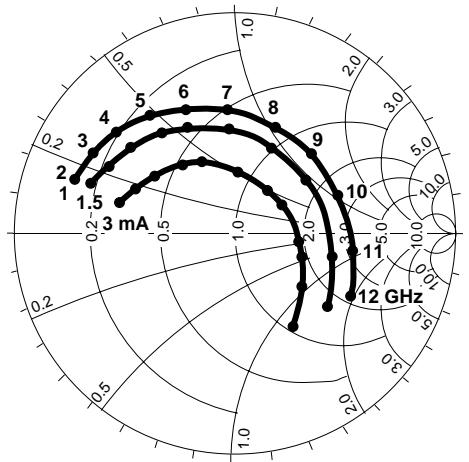


Figure 7. Typical Admittance Characteristics, 5082-2207 and 5082-2774 with Self Bias.

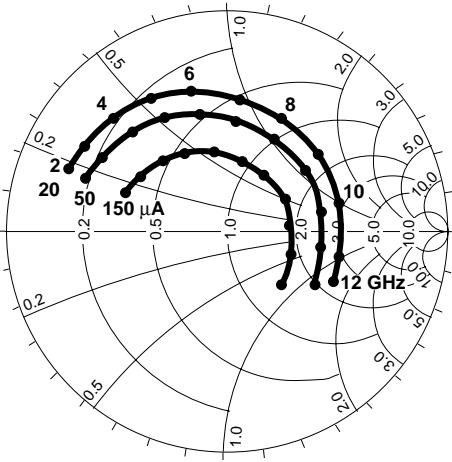


Figure 8. Typical Admittance Characteristics, 5082-2207 and 5082-2774 with External Bias.

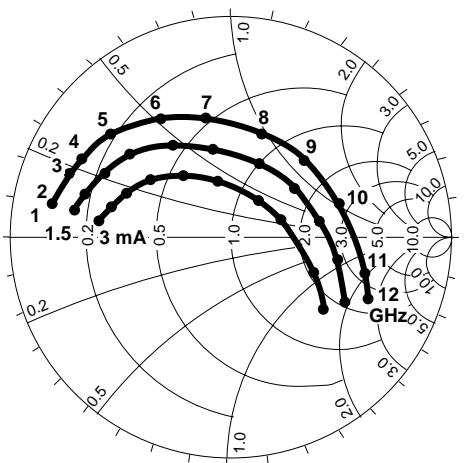


Figure 9. Typical Admittance Characteristics, 5082-2209 and 5082-2794 with Self Bias.

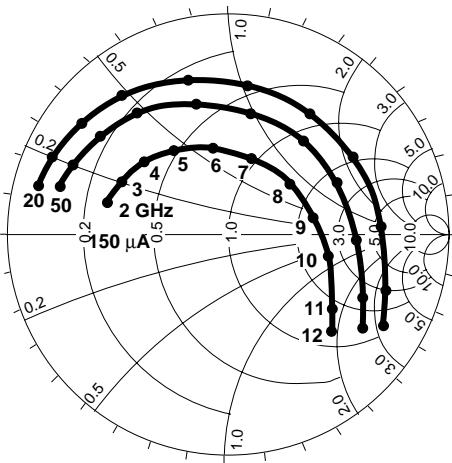


Figure 10. Typical Admittance Characteristics, 5082-2209 and 5082-2794 with External Bias.

## Typical Parameters, continued

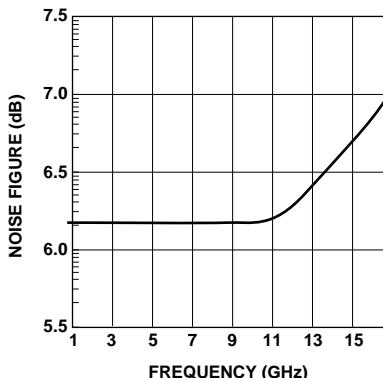


Figure 11. Typical Noise Figure vs. Frequency for 5082-2209, -2794.

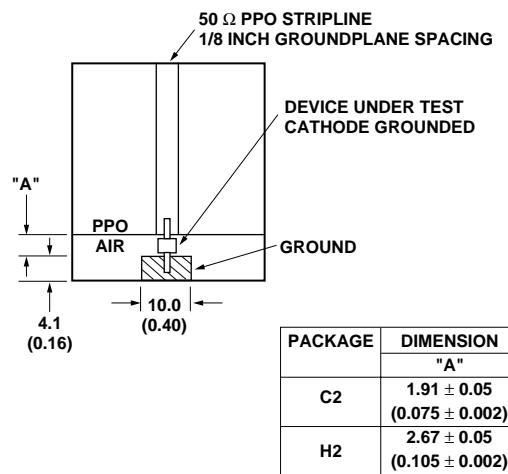
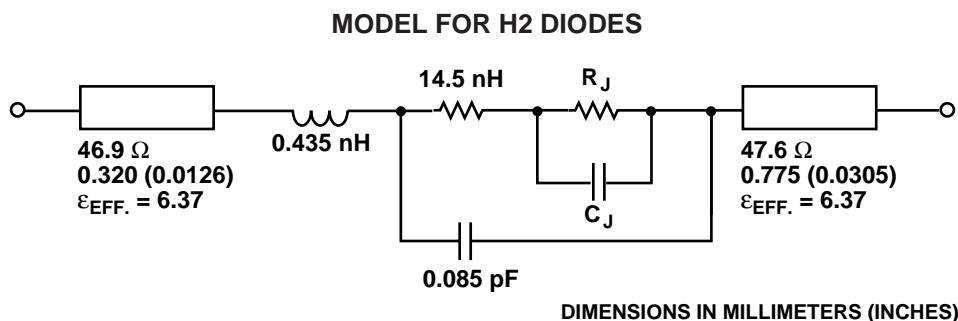
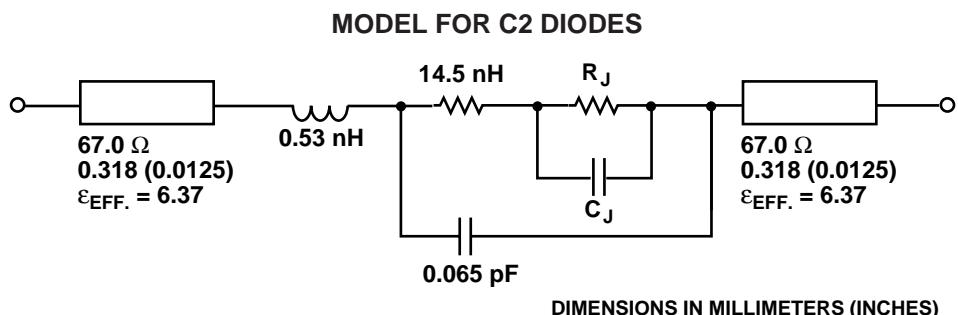


Figure 12. Admittance Test Circuit.



Parameter	Symbol	1 mA Rect. Current	20 μA Ext. Bias	Units
		5082-2765	5082-2765	
Junction Resistance	R <sub>J</sub>	258	545	Ω
Junction Capacitance	C <sub>J</sub>	0.255	0.302	pF



Parameter	Symbol	1 mA Rect. Current	20 μA Ext. Bias	Units
		5082-2207, 5082-2774	5082-2207, 5082-2774	
Junction Resistance	R <sub>J</sub>	338	421	Ω
Junction Capacitance	C <sub>J</sub>	0.189	0.195	pF